SN74ALVCH16843 18-BIT BUS-INTERFACE D-TYPE LATCH WITH 3-STATE OUTPUTS

DGG OR DL PACKAGE

(TOP VIEW)

1CLR

10E

2

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56 1LE

55 1 1 PRE

- Member of the Texas Instruments Widebus™ Family
- EPIC[™] (Enhanced-Performance Implanted CMOS) Submicron Process
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages

description

This 18-bit bus-interface D-type latch is designed for 2.3-V to 3.6-V V_{CC} operation.

The SN74ALVCH16843 features 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. This device is particularly suitable for implementing buffer registers, unidirectional bus drivers, and working registers.

The SN74ALVCH16843 can be used as two 9-bit latches or one 18-bit latch. The 18 latches are transparent D-type latches. The device has noninverting data (D) inputs and provides true data at its outputs.

A buffered output-enable (\overline{OE}) input can be used to place the nine outputs in either a normal logic state (high or low logic levels) or a high-impedance state. The outputs also are in the high-impedance state during power-up and power-down

54 1D1 1Q1 L 3 GND [53 GND 1Q2 🛮 5 52 1D2 1Q3 🛮 6 51 1D3 50 **□** V_{CC} v_{cc} [7 1Q4 📙 49 🛮 1 D4 1Q5 48 🛮 1D5 9 1Q6 L 10 47**∐** 1D6 GND [] 46 GND 11 45 1D7 1Q7 **[]** 12 1Q8 🛚 44 🛮 1D8 13 43 1D9 1Q9 🛚 14 2Q1 [] 42 | 2D1 15 2Q2 41 2D2 16 2Q3 📙 17 40 2D3 39 GND **GND | 1** 18 2Q4 [38 🛛 2D4 19 2Q5 [] 20 37 D 2D5 2Q6 ∏ 21 36 2D6 V_{CC} L 22 35 V_{CC} 2Q7 L 23 34 🛮 2D7 2Q8 II 24 33 2D8 GND [] 32 GND 25 2Q9 [26 31 D 2D9 2OE 30 2PRE 27 29 🛮 2LE 2CLR 28

conditions. The outputs remain in the high-impedance state while the device is powered down. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.

The output-enable (\overline{OE}) input does not affect the internal operations of the latch. Previously stored data can be retained or new data can be entered while the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating inputs at a valid logic level.

The SN74ALVCH16843 is available in TI's shrink small-outline (DL) and thin shrink small-outline (DGG) packages, which provide twice the I/O pin count and functionality of standard small-outline packages in the same printed circuit board area.

The SN74ALVCH16843 is characterized for operation from –40°C to 85°C.



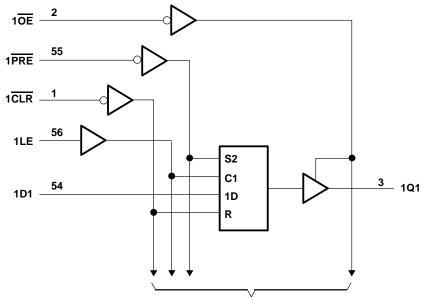
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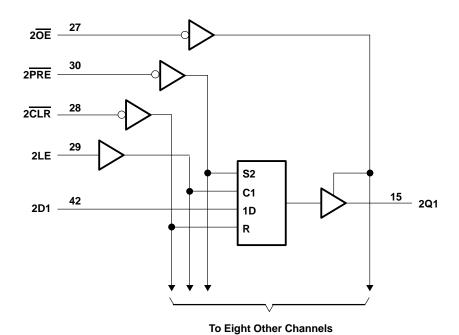


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logic diagram (positive logic)



To Eight Other Channels



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FUNCTION TABLE (each 9-bit latch)

INPUTS				OUTPUT	
PRE	CLR	ΟE	LE	D	Q
L	Х	L	Х	Χ	Н
Н	L	L	Χ	Χ	L
Н	Н	L	Н	L	L
Н	Н	L	Н	Н	Н
Н	Н	L	L	Χ	Q_0
Х	Χ	Н	Χ	Χ	Z

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 V to 4.6 V
Input voltage range, V _I (see Note 1)	
Output voltage range, VO (see Notes 1 and 2)	
Input clamp current, I _{IK} (V _I < 0)	
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, I _O (V _O = 0 to V _{CC})	±50 mA
Continuous current through each V _{CC} or GND	±100 mA
Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 3): DGG package	1 W
DL package	1.4 W
Storage temperature range, T _{sta}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 - 2. This value is limited to 4.6 V maximum.
 - 3. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the *ABT Advanced BiCMOS Technology Data Book*.

recommended operating conditions (see Note 4)

			MIN	MAX	UNIT	
Vcc	Supply voltage			3.6	V	
VIH	High level input valtage	V _{CC} = 2.3 V to 2.7 V	1.7		V	
	High-level input voltage	V _{CC} = 2.7 V to 3.6 V			V	
VIL	Low lovel input voltage	V _{CC} = 2.3 V to 2.7 V	0.7		V	
	Low-level input voltage	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		0.8	V	
VI	Input voltage		0	VCC	V	
VO	Output voltage		0	VCC	V	
ІОН		V _{CC} = 2.3 V		-12	2	
	High-level output current	V _{CC} = 2.7 V		-12		
		V _{CC} = 3 V		-24		
loL		V _{CC} = 2.3 V		12		
	Low-level output current	V _{CC} = 2.7 V		12	mA	
		V _{CC} = 3 V		24		
Δt/Δν	Input transition rise or fall rate		0	10	ns/V	
TA	Operating free-air temperature		-40	85	°C	

NOTE 4: Unused control inputs must be held high or low to prevent them from floating.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PA	RAMETER	TEST CONDITIONS		VCC	MIN	TYP†	MAX	UNIT	
VOH		I _{OH} = -100 μA		2.3 V to 3.6 V	V _{CC} -0	.2			
		$I_{OH} = -6 \text{ mA},$	V _{IH} = 1.7 V	2.3 V 2					
			V _{IH} = 1.7 V	2.3 V	1.7			V	
	I _{OH} = -12 mA	V _{IH} = 2 V	2.7 V	2.2			\ \ \ \ \ \		
			V _{IH} = 2 V	3 V	2.4				
		I _{OH} = -24 mA,	V _{IH} = 2 V	3 V	2				
		I _{OL} = 100 μA		2.3 V to 3.6 V			0.2		
		$I_{OL} = 6 \text{ mA},$	V _{IL} = 0.7 V	2.3 V			0.4		
V _{OL}		Jan. 40 mA	V _{IL} = 0.7 V	2.3 V			0.7	V	
		I _{OL} = 12 mA	V _{IL} = 0.8 V	2.7 V	/		0.4		
		I _{OL} = 24 mA,	V _{IL} = 0.8 V	3 V			0.55		
lį		$V_I = V_{CC}$ or GND		3.6 V			±5	μΑ	
I _I (hold)		V _I = 0.7 V		0.014	45				
		V _I = 1.7 V		2.3 V	-45				
		V _I = 0.8 V		0.14	75			μΑ	
		V _I = 2 V		3 V	-75				
		$V_1 = 0 \text{ to } 3.6 \text{ V}^{\ddagger}$		3.6 V			±500	1	
loz		$V_O = V_{CC}$ or GND		3.6 V			±10	μΑ	
Icc		$V_I = V_{CC}$ or GND,	IO = 0	3.6 V			40	μΑ	
∆lcc		One input at V _{CC} – 0.6 V,	Other inputs at V _{CC} or GND	3 V to 3.6 V			750	μА	
Ci	Control inputs Data inputs	V _I = V _{CC} or GND		3.3 V				pF	
Co	Outputs	VO = VCC or GND		3.3 V				pF	



[†] Typical values are measured at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^{\circ}\text{C}$. ‡ This is the bus-hold maximum dynamic current required to switch the input from one state to another.

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